

The approval of the patent by the Taiwan Intellectual Property Office (TIPO)

The Management Board of XTPL ("Issuer", "Company", "XTPL") hereby reports that on 25 March 2024 it received the notice of allowance and information related to allowed claims issued by the Taiwan Intellectual Property Office. The patent application has been examined and is allowed for issuance as a patent for an invention "Method for forming structure upon a substrate".

The application procedure for this patent was initiated on 21 March 2017. This is also the date when patent protection started for the invention. The final formal requirement for obtaining the patent is to pay the necessary fee. Should the requirement not be met, the Company will communicate this in a separate current report.

The patent protection will increase the value of the potential commercialization of the Company's technology with respect to the Issuer's technological solutions for the next generation electronics market. The reported event confirms continued delivery of the Company's strategy of building a patent cloud for its proprietary technology and products, which will contribute to building the Issuer's credibility among potential industrial clients.

In view of the above, and considering the confirmation of uniqueness of the Company's technological solutions, and then the outlook for the Issuer's perception by investors, the Issuer's Management Board has decided that the notice of allowance and information related to allowed claims should be deemed confidential information. For this reason, in the opinion of the Management Board, the information meets the criteria set out in Article 7(1) of the MAR.

Jacek Olszański

Management Board Member

**XTPL S.A., a joint stock
company with its registered
office in Wrocław**

Legal basis:
Article 17(1) MAR -
confidential information